

New production technologies for printed electronics

Coatema

02/06/25

Agenda

1. Introduction

- 2. The printed electronics market
- 3. Bridging the gap
- 4. Technologies & processes
- 5. Slot die for printed electronics
- 6. Printing processes
- 7. Nanoimprint
- 8. Drying
- 9. SALD

10.Summary



1.

Introduction



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Group of companies



Located in Hamburg

- Located in Norderstedt
- ✓ Approx. 50 employees
- Located in Dormagen



Represented worldwide





Coatema equipment platform strategy for lab2fab



- State-of-the-art research and development equipment
- Sheet-to-sheet to roll-to-roll systems on smale scale & footprint

- Pilot
- Proven processes for printing, coating and laminating equipment
- Highest-quality pilot lines enable stable pilot production and reduce cost of operation
- Scaling laboratory equipment to enable pilot production

- Full-scale production lines
- Optimize the manufacturing process, including streamlining assembly, reducing material waste, and optimizing the carbon footprint



Our markets – Coatema focus areas



R&D centre



R&D centre USP

| | >>> | Process development ✓ Feasibility study ✓ Ink – process study ✓ Process analysis | Slot die coating simulations Proof of concept Small scale prototype |
|--|---------------------|---|---|
| | Ĩ | Test production ✓ Prototyping ✓ Near to market testing | TRL evaluationTraining of staff |
| | | Education ✓ Coating conference ✓ Partner trainings | Education of students Workforce training |
| | | <pre>Development of custom-n ✓ Prototyping</pre> | nade design for equipment ✓ Proof of concept |
| | Ś | Public funded research provide ✓ German funded ✓ Horizon 2020 | ojects know-how ✓ Global 2+2 projects ✓ B2B projects |







Coatema services as an overview

The Coatema R&D centre



Accelerate your innovation in our dedicated pilot facility with advanced lab & pilot lines and expert guidance – bridging the gap from #lab2fab.



The Coatema Coating Symposium



Join the global network of coating experts at our annual event, where cutting-edge developments meet industry collaboration for next-level innovation.



The Coatema Slot Die Masterclass



Master precision coating in our hands-on training program, led by industry specialists to optimize slot-die performance and product excellence.



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Our work in associations – global networking







Board Member: OE-A Advisory Board: Fraunhofer ITA

R&D services

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R&D customers



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R&D projects overview 2022 – 2025



2.

The printed electronics market









flexible - thin - robust - lightweight - stretchable





2010
2 Billion US\$
predominantly by OLED displays

2012

8 Billion US\$

predominantly by OLED displays

Potential

for a 50 Billion US\$ market within the next 10 years driven by OPV, lighting, displays, logic, memory/RFID, sensors







▲ Flexible, Printed and Organic Electronics Market (IDTechEx) 2022

Flexible, organic and printed electronics enables new applications and opens new markets

50+ Bn US\$ Market today, OLEDs, sensors, medtech

Large Potential driven by displays, sensors, wearables, OPV, lighting, RFID/NFC





OE-A Roadmap for Organic and Printed Electronics Applications







Flexible, organic and printed electronics solutions in important industry sectors

Automotive

OLED lighting for rear lights, ambient lighting by hybrid electronics, printed (radar) antennas, seat occupancy detection, seamless integration of touch sensors, smart HMI functions, integrated heating foils



Printing & Packaging Automated stock replenishment system, large area capacitive sensor floor, thin film encapsulation for OLED, RFID, NFC, flexible batteries, smart packaging for food and medical with time and temperature tracking, light emitting packaging (EL, OLED), non-light-emitting technology (EPD, ECD)



Consumer Electronics

Foldable & flexible displays for smart phones / tablets / wearables; Curved touch surfaces with sensing & signage for white goods; smart wearables and textiles; smart patches for sports tracking, OLED lighting; printed Batteries, printed QD layers in TVs, Printed OLED TVs and Monitors



Smart Buildings Sensors for material monitoring, energy management (climate, smart windows) and wellbeing (humidity, gas); energy autonomous sensors; Heating and touch elements; BIOPV; OLED lighting, OPV on walls



Healthcare

Smart medical packages for therapy monitoring; textiles with embedded pressure sensors, temperature/ humidity sensors, continuous real-time heart monitoring, patches for therapy and vital parameter monitoring; sensors for on - and off-body biomarker diagnosis; smart wound treatment and bandages; Sensors for medical applications (Blood -Glucose-Test, intelligent incontinence solution), pressure sensor (Dental occlusion measurement films



Internet of Things

Connected home appliances, autonomous cars and smart wearables, precision agriculture, environmental monitoring, Supply chain management with item level tagging, data loggers for containers, voyage optimization







Forecast for market entry of OPE applications

Short, medium and long term forecasts for key industry sectors:

- ✓ Automotive
- Consumer Electronics
- ✓ Healthcare
- Printing & Packaging
- ✓ Smart Buildings
- ✓ Internet of Things





The future market – Key trends







Digital fabrication as a trend in PE





Digital fabrication is happening – lot size 1 is real.

Why now?

Digital fabrication and additive manufacturing will disruptively change the world of manufacturing we know today!



Disruptive!





The "4th" industrial revolution

- Digital fabrication means to have the ability to produce lot size one for the same cost as for lot size million.
- Manufacturing at the site with personalized design for each customer.
- It will change global manufacturing to local manufacturing.
- Productivity boost for the old economies and Europe, the real 4th revolution.
- The "Manufaktur" will come back as the "digitale Manufaktur 2.0".







3.

Bridging the gap



Bridging the gap



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From 2008 till today – PE as the flexible bridge



Bridging the gap



Printed electronics – bridging the gap



What could be the pathway on to textiles or also integrated into textiles?







From 2008 till today – PE as the flexible bridge



Bridging the gap



Case study – design principles

Authors: Juha-Veikko Voutilainen, Tuomas Happonen, University of Oulu





Figure 1. Printed temperature sensor and layout



Figure 2. A remote readable RH sensor.

Authors: Tuomas Happonen, Juha-Veikko Voutilainen, University of Oulu



(a) (b) (c) Figure 1. Printed capacitive humidity sensor structures



Figure 1. Capacitive touch sensor



Figure 1. Electrochemical biosensor

Authors: Elina Jansson, Jukka Hast, VTT



Figure 1. Printed gas sensors

PrintoCent



Designer's Handbook 2014

4.

Technologies & processes





Coating parameters

| Coating chemistry | Coating processes | Process control | Drying |
|--|---|--|---|
| Rheology Viscosity Viscoelasticity Type of solvents Solid content Van der Waals force Sheer ratio Adhesion/Cohesion | Coating systems Single or multilayer coatings Direct coatings Transfer (indirect) coatings Substrate speed Layer thickness Coating accuracy | Process layout Tension control system Material guiding system Inline parameter control Quality control | Convection drying Contact drying Infrared drying Sintering NIR High frequency UV crosslinking systems |
| Substrate | Pretreatment | Environment | Finishing |
| Surface tension Dimension stability Surface structure Contact angle | ✓ Corona ✓ Plasma ✓ Cleaning | Humidity Temperature Inert conditions | Calendaring Embossing Slitting |

Technologies & processes



Processes





Upscaling from lab 2 fab – going to fab-technologies





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From lab 2 fab




Process parameters

Process parameters are:

- Operation speed
- Rheology of coating and printing inks
- Substrate condition
- Tension control MD / CD
- Edge control
- Resolution and registration accuracy of printing / laminating systems
- Precision of coating operations
- Curing / drying / crosslinking



Inline process integration

| <u>Tension control</u> | Edge guide control | Quality control |
|---|---|---|
| ✓ Load cell ✓ Dancer ✓ Dulling devices | Different sensorsMechanical stress | Particle contamination analysis |
| Pulling devices Design of drives | | Defect detection |
| | | Thickness control |
| | | |
| Registration control | Process analysis | Function control of the device or layer |
| Registration control ✓ Camera | Process analysis ✓ Statistic parameters ✓ Product flow analysis | Function control of the device or layer Big data (Cloud) |
| Registration control ✓ Camera ✓ Fiber optic | Process analysis ✓ Statistic parameters ✓ Product flow analysis ✓ Viold | Function control of the device or layer Big data (Cloud) |
| Registration control ✓ Camera ✓ Fiber optic ✓ Design of drives | Process analysis ✓ Statistic parameters ✓ Product flow analysis ✓ Yield ✓ Cost of ownership | Function control of the device or layer Big data (Cloud) Artificial inteligence |





Inline process integration and measuring points

Winder speed / Diameter / Cross position / tension / particle contermination / substrate defects / registration marks



• Amount of measurements per time





Winding / cleaning



Unwinding cabinet

- Can receive rolls with core of 3 inch
- ✓ Max diameter of 500 mm
- ✓ Max weight 50 kg
- Web width of 300 mm
- Automated forward and reverse movement of the web
- ✓ Speed of 1 20 m/min.
- ✓ Tension control of the web within the range of 5 250 N

Web cleaning system

✓ Contact cleaning rollers for particles of >1µm diameter





Inline process integration



1st Printing ✓ Web surface activation with Plasma Treatment

Dryer 1 ✓ 3 meter dryers ✓ Hot air and heated nitrogen ✓ Temperatures up to 230 °C





Slot die coating station compatible for materials used in OEs

- Print solutions with viscosity range of 10 – 1000 mPas
- ✓ The above range can lead to layer thickness range of 10 - 1000 nm
- ✓ Lateral accuracy of ±1%





Laser patterning



Laser scribing/patterning

- Picosecond laser for patterning OE materials
- ✓ 3 meters cabinets
- Tension and driving web control
- ✓ System ±100 µm of accuracy

Technologies & processes



Module for the registration camera





Technical specifications:

- ✓ Measurement accuracy = +/-20 µm
- ✓ ATEX proof
- ✓ 300 mm roller width
- ✓ Web speed:
 - 1 20 m/min; Optimum speed is 3 - 20 m/min.
- PLC-driven correction adjustment system
- ✓ Module to be operated under N₂



Rotary screen printing



2nd printing station

- ✓ Rotary screen printing
- ✓ Coating width of 300mm
- ✓ Lateral accuracy ±5%

Dryer 2✓ 3 meters dryers✓ Hot air and heated nitrogen

✓ Temperatures up to 230°C



Inline process integration

Inkjet station Inkjet station System



Coatema software



Already integrated: Fujifilm Dimatix



Encapsulation



Rewinding station

- The rewinding station has a retaining roller
- Identical specs to the unwinding station
 - ✓ 3 inch core rolls
 - Automated forward and reverse movement of the web
 - ✓ Speed of 1 20 m/min.
 - ✓ Tension control and edge guide system

Lamination / delamination station

- Compatible with 300 mm web width
- ✓ Web control with edge guide system
- \checkmark Lateral accuracy of ±100 μm / 20 μm



Inline quality control – Ellipsiometry and inline Raman by Horiba









Summary



- ✓ 19 m in length
- ✓ 300 mm working width
- ✓ 30 m/min production speed
- ✓ 3 print stations
- ✓ Plasma treatment
- ✓ 6.000 mm dryers

- ✓ Registration control
- Laminating station
- ✓ 36 measuring points
- 3 quality control systems
- How many data points in one 7h shift?



Coatema Perovskite PV Manufacturing plant – Click&Coat[™]





Coatema Perovskite PV Manufacturing plant – Click&Coat[™]











5.

Slot die for printed electronics



Slot die



Basic principle





Coating parameters

| Ink properties | Coating processes | Process control | Drying |
|--|---|--|---|
| Rheology Viscosity Viscoelasticity Type of solvents Solid content Van der Waals force Sheer ratio Adhesion/Cohesion | Coating systems Single or multilayer coatings Direct coatings Transfer (indirect) coatings Substrate speed Layer thickness Coating accuracy | Process layout Tension control system Material guiding system Inline parameter control Quality control | Convection drying Contact drying Infrared drying Sintering NIR High frequency UV crosslinking systems |
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Slot die





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Basics of slot die coating – range of parameters



Coating speed ✓ 0.1 - >1000 m/min

Ink viscosity ✓ 1 – 300 000 mPas

Layer thickness (dry) \checkmark 0.1 – >200 μm

Coating accuracy \checkmark <1% (2 - 5%)

Coating width
✓ up to approx. 3 m



Basic principle





Basic principle













- Meniscus is formed between die lips and substrate
- Adhesive stabilization of meniscus by die lips
- Very low minimum flow rate possible
- For a stable process the range of rheological parameters is limited
- Preferrably for low coating speed





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Theoretical background – "Basic" fluid dynamics for advances geometries

| $\oint \rho v dA = 0$ Continuity equation (conservation of m | Any flow of liquids is described by a set of differential equations: |
|--|--|
|--|--|

To describe the meniscus flow of a slot die means, to solve these differential equations for given boundary conditions.

Can be done by appropriate computer programs.

$$\frac{\partial v}{\partial t} + (v\nabla) \mathbf{v} = \frac{(-\nabla p + \eta \Delta v + f)}{\rho}$$

Navier-Stokes-equations (equations of motion for incompressible fluids, $\rho = \text{const}$) $\Delta, \nabla =$ differential operators



Theoretical background



Contrary to a widespread misunderstanding the wet coating thickness does not depend on the shim thickness.

Shim thickness and distance to substrate only help to stabilize the meniscus.

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Slot die



Why should a slot die coat homogeneously?





Fluids in the manifold: 1.5D approximation



Pressure drop $\Delta p(x)$ via pumping through finitely sized distribution chamber leads to:

$$p(x) = p_0 \cdot \frac{\cosh \frac{\lambda}{\lambda}}{\cosh \frac{W}{\lambda}}$$

Theoretical pressure Theoretical thickness profile: $p(x) = p_0 \cdot \frac{\cosh \frac{W - x}{\lambda}}{W} \qquad h(x) = \frac{B \cdot h_0}{\lambda} \cdot \frac{\cosh \frac{W - x}{\lambda}}{\sinh \frac{W}{\lambda}}$

 $\lambda = \left| \frac{3\pi \cdot l \cdot r^4}{2\delta^3} \right| \text{ ,slot die geometry parameter"}$



Calculation of the meniscus stability





Coatema standard layout – one design among many available





Structured coating – levels of complexity

| | Web direction | | Current status |
|---|---------------|---|--|
| 1 | | Full area, homogeneous | Requirements are met, thickness profile variation of 0.5 % |
| 2 | | Stripes downweb | Requirements are met, good edge definition |
| 3 | | Stripes crossweb (intermittent coating) | Requirements are partially met, edge definition of 0.5 – 1 mm depending on liquid |
| 4 | abc | Arbitrary patterns | Requirements are not met, concepts for realization exist, research project is going on |



Level 2 – downweb stripes



Downweb stripes of different width ...

... are made by appropriate shims, lasercut from steel or kapton



Level 2 – downweb stripes

Stripe widening by capillary forces at the edges of the shim teeth Shim Manifold Manifold Slot area Slot area 100µ typ Moving substrate \odot or \odot

Problem:



Level 2 – downweb stripes


Slot die coating



Level 2 – downweb stripes



Meniscus guide

Shim

Meniscus guide + shim







Structured coating – crossweb stripes (intermittent)





Standard techniques for intermittent coating



Pump: stop – reverse – restart

Slot die body:

move back – move forth to minimum gap – move back to working gap (wedge procedure)

Slot die internal:

stop and redirect the flow by shutters and valves. Pump flow continues, die flow stops.

All 3 techniques (single or in combination) work quite well, if the viscosity is rather high and the required edge definition is not more precise than around 1 mm. All techniques may be combined with a vacuum pump upstream to stabilize the meniscus and suck away residual liquid.

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Structured coating – reason for bad edges at low viscosity

- Mensicus has to be interrupted
- Low viscous liquids do not break along a straight line
- Meniscus has to be sucked back and restored
- ✓ Speed is of essence
- → For low viscosity, all of the three methods are too slow and too indirect







Structured coating – new concepts for low viscosity liquids

Two new concepts allow to interrupt and restore the meniscus much faster:

Double chamber slot die

with modified chamber geometry and Piezo driven suck back pump

✓ Switching lip slot die

with a Piezo driven lip opening mechanism that sucks back the meniscus right where it is





Structured coating – the switching slot die lip



Slot die with movable lips: coating mode

- lip
- slot volume V
- bendable lip B
- bending slot S







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Structured coating – the switching slot die lip



Slot die with movable lips: stop mode

Bendable lip B flips open

Volume V increases and sucks away the meniscus

- L lip
- V slot volume
- B bendable lip
- S bending slot







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Slot die coating



A Trigger

A Trigger

Structured coating – technical implementation with Piezo-Drive



stop mode and vice versa





Structured coating – technical implementation with bendable lips



Slot die coating



Technical implementation with bendable lips in action





Structured coating – stages of lip motion



Slot die coating



Structured coating – ongoing trials: stripe coating of fuel cell paste







Simulation of anode Coating with slot die

- Example for anode electrode coating
- Fluid data taken from real world (shear-thinning power law fluid)
- Process parameters for
 90 m/min 400 µm coating and
 300 mm width
- No "fancy" slot-die "just"
 Coatema standard







Streamlines and pressure distribution in the slot die





Meniscus makes or breaks Homogeneity





Design of an inner manifold, slot die



Undergoes parameter sweep and iterative design changes to achieve optimal performance for the specific fluid

- **Goal:** ✓ Uniform Coating Thickness for the specific fluid
 - Design the die to handle variations in pressure, especially in cases where the complex fluid exhibits non-Newtonian behavior.



Coating process optimization



6.

Printing processes





Printing parameters

| Printing method | Printing speed (m/s) | Nip pressure (MPa) | Ink viscosity (Pas) | Layer thickness (µm) | Feature size (μm) | Registration (µm) |
|-----------------|-------------------------|--------------------------|------------------------|----------------------------|-------------------------|----------------------|
| Flexography | 3-10 | 0.1 - 0,5 | 0.01-0.5 | 0.04 - 8 | 40-80 | 20-200 |
| Gravure | 10-16 | 1.5 – 5 | 0.01-0.2 | 0.1 - 12 | 20 – 75 | >10 |
| Offset | 8-15 | 0.8 – 2 | 1-100 | 0.5 – 3 | 25 – 50 | >10 |
| Screen printing | 2 | _ | 0.1 - 50 | 3-100 | 75 – 100 | >25 |
| Inkjet | 1-5 | _ | 0.001 - 0.03 | 0.01-0.5 | 10-50 | <10 |
| | | | | 20 (UV) | | |



Printing parameters



Gravure printing





Flexo printing





Screen printing



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Inkjet printing





Inkjet printing





Integration of the "inking" system – current status



- Printing head and mounting (Fujifilm Dimatix Samba)
- ✓ Fluid recirculation system
- ✓ Power supply
- ✓ Computer



Integration of analysis and sintering units – current status



- Dantex dynamics "dropwatching"Velocity
- ✓ Size
- ✓ Sphericity
- Drying / Sintering
- ✓ Adphos NIR
- IR lamp
- ✓ Photonic sintering
- ✓ Hot air dryer



Integration into new and existing platforms

- Combination of print heads with high precision granit stone
- Several sintering methods possible
 - ✓ Hot air dryer to remove solvents (LEL)
 - NIR / IR / Photonic sintering for conductivity
- Droplet analysis
- Possibility to combine inkjet with NIL





Integration – machine layout







Integration – machine layout





Integration – machine layout





Summary

- ✓ Inkjet provides a step towards a more flexible and customizable production
- ✓ Inkjet is successfully integrated in a R2R process on 300 mm width
- ✓ Width is scalable
- ✓ Speeds up to 10 m/min were tested
- ✓ Different curing / drying systems were tested
- ✓ A layout for a inkjet dedicated machine is available

7.

Nanoimprint





Basic principle of nanoimprint lithography



Nanoimprint lithography – technologies and processes



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Applications



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Translating from P2P to R2R





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R2R UV-NIL equipment



Test Solution R2R



Coatema2go


Equipment





Equipment

Rollimprint Production Line (Roll-to-Roll, Roll-to-Plate)
 Films up to 1.0m width, panels up to 1.0m x 1.6m
 Cleanroom class ISO 5









Equipment

R2R + R2P-Machine

Specs:Working width R2R: 1100 mmDimensions R2P:1000 mm x 1600 mmSpeeds:6 - 60 m/minCoating Unit:Slot die coating







Coatema UV-NIL and Hot embossing in one unit

Hot embossing parameters:

Pressure up to 6bar, Temp. up to 170°C, web speed up to 50 m/min, foils up to 250 mm in width





Rank, A., Lang, V. & Lasagni, A. F. High-Speed Roll-to-Roll Hot Embossing of Micrometer and Sub Micrometer Structures Using Seamless Direct Laser Interference Patterning Treated Sleeves. *Adv. Eng. Mater.* **19**, 1–8 (2017).

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Nanoimprint lithography – technologies and processes





Nanoimprint lithography – technologies and processes





- ✓ 500 mm working width & 100 m/min
- ✓ 9m high performance Drying (Convection + IR)
- ✓ Multi Coating Unit
- Turret-winder for continuous production
- ✓ 200kN/m imprint pressure





State of the art UV-NIL technology / machinery







Design concept – high precision R2P S&R tool for UV-NIL



- ✓ R2P Vacuum table for samples up to 300 x 300 mm²
- \checkmark Granite base and vacuum table with 1 μm precision
- Magnetic linear drives + air gearings + interpolated high resolution linear encoders (resolution in <500 nm in xy and ±60 mas Rotation)
- Dust free housing with constant temperature
- Transparent acrylic based imprint roller with sub μm flatness
 - Integrated high power UV LED-lamp
 - Integrated interferometric high resolution camera system







Design concept – high precision R2P S&R tool for UV-NIL







SOLID: Innovative solid-state batteries based on sol-gel materials with Li-metal anode and implemented 3D structuring

- R2R manufacturing of solid-state thin film batteries
- Innovative cell concepts
 - Implementation of a lithium metal anode
 - ✓ Sol-gel cathode and electrolyte
 - ✓ 3D patterning of battery layers





Li metal

Partners:



Funding:



Federal Ministry of Education and Research FKZ: 03XP0129C

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Upscaling of the UV-nanoimprint process







Upscaling of the UV-nanoimprint process



 Implementation of a transparent imprint roller on 500 mm working width

- ✓ Transfer from lab scale R2P
 → pilot scale R2R process
- ✓ Feature size 300 nm 1 µm
- Process must be suitable for non-transparent substrates



Reference sample prepared using nanoimprint lithography (Fraunhofer ISE)





Upscaling of the UV-nanoimprint process





Transparent imprint roller with 500 mm working width

Design concept of the Click&Coat[™] module with the transparent imprint roller

- Implementation of a transparent imprint roller on 500 mm working width
- ✓ Integration into the modular Click&Coat[™] pilot line

✓ Transfer from lab scale R2P
 → pilot scale R2R process
 ✓ Feature size 300 nm - 1 µm
 ✓ Process must be suitable for non-transparent substrates



Reference sample prepared using nanoimprint lithography (Fraunhofer ISE)

8.

Drying technologies





Introduction thermal drying – Coating parameters

| Coating chemistry | Coating processes | Process control | Drying |
|--|---|--|---|
| Rheology Viscosity Viscoelasticity Type of solvents Solid content Van der Waals force Sheer ratio Adhesion/Cohesion | Coating systems Single or multilayer coatings Direct coatings Transfer (indirect) coatings Substrate speed Layer thickness Coating accuracy | Process layout Tension control system Material guiding system Inline parameter control Quality control | Convection drying Contact drying Infrared drying Sintering NIR High frequency UV crosslinking systems |
| Substrate | Pretreatment | Environment | Finishing |
| Surface tension Dimension stability Surface structure Contact angle | ✓ Corona✓ Plasma✓ Cleaning | Humidity Temperature Inert conditions | Calendaring Embossing Slitting |



Dryer specs needed for the layout

Information about the substrate

- Web weight weight per unit area
- ✓ Web material
- ✓ Specific heat of web
- Temperature limitations
- Operating web tension tension sensitivity
- Special characteristics



The Click&Coat[™] in production scale





Introduction thermal drying – As general as possible(!?)



Heat Conduction/ Heat Diffusion
 Heat Convection/ Mass Transfer
 Radiation





Basics mass + heat transfer – Drying dynamics: The Boundary Layer

An isolating air layer forms just on top of the coated film

- ✓ Without convection mass+heat transfer is limited to diffusion and therefore slow.
- Convective (laminar or turbulent) flow needs to be applied without sacrificing the coating surface.





Basics mass + heat transfer – Drying dynamics: Hot air drying

- Heating and vapor transport combined
- Bulk heating by thermal conductivity from surface
- ✓ Isolating layer to be overcome by air flow
- High air flow deteriorates surface
 Temperature easy to limit
 Slow





Basics mass + heat transfer

Nothing is as easy as it seems: Diffusion limit and skinning

- Irying is also limited by solvent diffusion (at least in the final state of low residual solvent content).
- ✓ If the internal diffusion is slower than the evaporation from the surface, then a skin may be created.
- The skin acts as a barrier. The remaining diffusion through the skin may be slower than the wet diffusion by many orders of magnitude.



So the initial evaporation must be reduced by low temperature and/or by partially saturated atmosphere. Despite reduced evaporation the total drying time then may be shorter than at full initial evaporation.



Basics mass + heat transfer – Drying dynamics: Drying zone design

- ✓ Downweb temperature profiles can be realized by partitioning the dryer in different zones with different drying parameters.
- But temperature uniformity is difficult.
 Possible cause: Mixing of hot and cool air at unintended leakages by Venturi effect.
- Experience shows, that there is always a compromise: Good temperature uniformity requires low homogeneous air
 Dryer 1
 flow. High air flow results in less temperature uniformity.





Industrial drying systems





Industrial drying systems





Industrial drying systems





Industrial drying systems





Industrial drying systems





Flotation Click&Coat[™] dryer prinziple





Drytec Click&Coat[™] dryer prinziple



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Basics mass + heat transfer: (N)IR technology



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Light-Structure interaction

 Surface reflection R
 Solute absorption α and scattering ε
 Internal reflection R
 Solvent absorption α
 Substrate absorption α



Incident NIR/IR light: $I_{in}(\lambda)$

Solute: $c(d_{\text{coat}}(t), t), \epsilon(\lambda), d(t)$

Solvent: $R(\lambda), \alpha(\lambda), d(t)$

Substrate: $R(\lambda), \alpha(\lambda), d_{sub}$ Drying technologies – NIR Drying Theory



Thermodynamic Model





IR / NIR Drying – Infrared drying



Heraeus



IR / NIR Drying – Infrared drying



Heraeus



Hotair oven: 50m (10 zone)

IR at first 25m (5 zone) for boost

Heating distance : 100mm

Qty of IR : 60 *3.1Kw = 186Kw



IR technology – combined hot air / IR dryer in 2010






Laser drying of battery slurry

- Typically, a high-power laser, such as a diode laser o a fiber laser, is used for this purpose
- The laser passing through the optics is directed at a large
- The absorbed laser energy rapidly heats the solvent in the slurry, causing it to evaporate
- The quick drying might help preventing the formation of cracks or defects in the electrode
- Laser drying is more energy-efficient compared to traditional drying
- Laser drying can be adapted for use in highvolume battery manufacturing processes.

[1] DEGENET al. (Life cycle assessment of the energy consumption and GHG emissions of state-of-theart automotive battery cell production) 2022 [2] KUPPER et al. (The future of battery production for electric vehicles) 2018



Source: Laserline



Laser drying

Laser System: The laser should be capable of delivering the necessary energy for solvent evaporation without damaging the electrode material.

Temperature Control: Implement temperature control systems within the drying chamber to ensure that the slurry is dried at the suitable temperature.

Gas Atmosphere: Consider the use of inert gases or controlled atmospheres within the drying chamber to prevent unwanted reactions or oxidation of the electrode materials during the drying process.

Monitoring and Control: Incorporate sensors and monitoring systems to continuously measure key parameters such as temperature, humidity, and laser power.

Drying Chamber: Design a drying chamber that allows for precise control of temperature, airflow, humidity, etc. to assure a **uniform and efficient drying**.



Laser dryer

Coatema's design



Geometry used for simulation





Web speed 30m/min, in -x direction

Pressure

Air velocity







Airflow in 3D, testing different design possibilities



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Airflow in 3D, testing different design possibilities

- The air is blown in a transverse direction to the web
- 280 mm x 350 mm laser area





Drying technologies



Airflow in 3D, testing different design possibilities



9.

Spatial ALD















SALD BV

SALD BV is an Eindhoven (NL) based Spatial ALD-equipment specialist serving the following green growth markets:

- Li-ion batteries & SSB coatings
- next-gen thin-film solar (OPV, perovskites)
- fuel-cells and electrolyzers
- Membranes & packaging foils
 - ✓ We have over 10 years industrial experience with Spatial ALD processes
 - We supply compact Spatial ALD machine for Research and small-scale production
 - ✓ Our technology is scalable from lab-scale up to 24/7 high-volume production





Classic ALD vs. Spatial ALD

Temporal ALD:

Gas-phase self-limiting deposition process. One atomic layer per cycle

Temporal ALD:

Precursor (A) and co-reactant (B) are **separated in time** in vacuüm

Spatial ALD (SALD): Precursor (A) and co-reactant (B) are **separated in space** in atmospheric pressure







Temporal ALD vs. Spatial ALD & benefits ALD

| | Temporal ALD | Spatial ALD (SALD) |
|---|--------------|---------------------------|
| Processing | Batch only | In-line / continues / R2R |
| Atmospheric pressure | No | Yes |
| Single-sided deposition possible | No | Yes |
| Typical deposition rate (Al ₂ O ₃) | 0.2 nm/min | 60 nm/min |

- High quality material
- Precise control in film-thickness
- Excellent uniformity
- Wide range of materials such as: metaloxides, metalnitrides, sulfides, fluorides, metals etc.
- Directly available: Al₂O₃, ZnO, ZnO:Al, SnO₂, TiO₂, SiO₂
- ✓ Low- and high temperature processing possible (50°C − 350°C)







Partners in Spatial ALD for Roll-to-Roll production







Spatial ALD for Roll-to-Roll production



Roll-to-Roll spatial ALD solution:

- ✓ 6 nm single pass coating at 60 m/min
- Substrate width on specification
- Demonstrator available from begin of December for demonstration / sampling

Contact us:





Explore. Develop. Integrate. Together.





In Summary

- Thermal and Plasma enhanced Spatial ALD concepts for lab and scalable into high volume production
- ✓ SALD is the only company with field experience of Spatial ALD for high volume production
- Spatial ALD can be integrated in existing high volume production lines
- ✓ SALD has experience with: Al₂O₃, ZnO, ZnO:Al doped, SnO₂, TiO₂ and plasma enhanced SiO₂
- \checkmark SALD systems can be equipped with a protective environment like N₂ or Ar.

SALD is an open and flexible company:

- Open for joint development programs
- Feasibility studies and sampling for new materials and/or applications
- Collaborate to find the best thin-film solution for your application
- Open for investments



10.

Summary



Summary



Bridging the gap

Needed for success:

- Reproducible results in every step of scale?
- Reality check if the approach is really scalable?
- ✓ Is the approach an approach for the real life production environment or is it rocket science?
- Are economies of scale reachable and when?
- ✓ Is durability really needed?
- ✓ Standardization of device manufacturing is the key for the industry
- ✓ Maybe small is the new big?



Do not hesitate to contact us!



Anything missing?

Let us know and we will make it happen!

Our R&D centre is worldwide the most versatile centre for coating, printing and laminating.

Sales department: sales@coatema.de

Download broschures & presentations





Thank you

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